

1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTCV8.00MT.

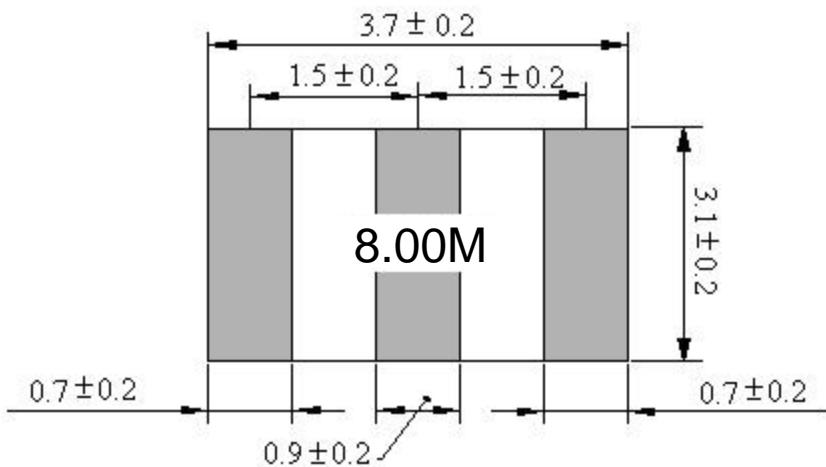
2. PART NO.:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
ZTTCV8.00MT		

3. OUTLINE DRAWING AND DIMENSIONS:

Appearance: No visible damage and dirt.

Dimensions:



UNIT: mm

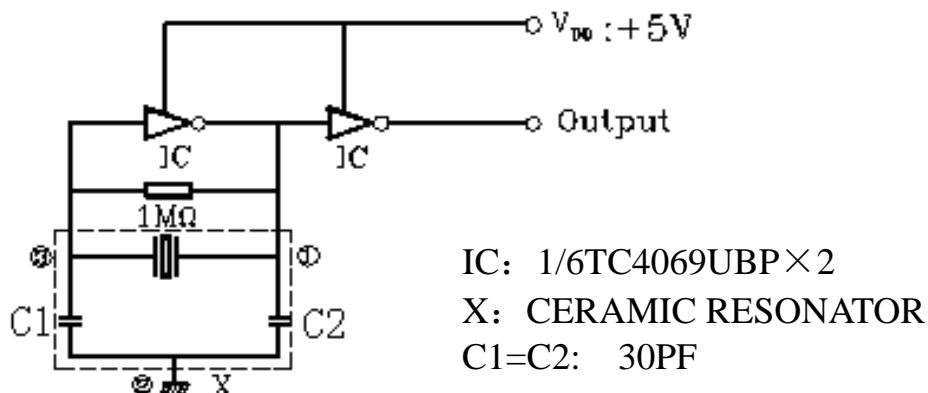
4. ELECTRICAL SPECIFICATIONS:

No	Item	Requirements
4.1	Oscillation Frequency Fosc (MHz)	8.000
	Frequency Accuracy (%)	± 0.5
4.2	Resonant Impedance R_o (Ω)max	30
4.3	Temperature Coefficient of Oscillation Frequency (%) max	± 0.3 (Oscillation Frequency drift -20°C to +80°C)
4.4	Withstanding Voltage	50 VDC, 1 min
4.5	Rating Voltage U_R (V) (1) D.C. Voltage (2) A.C. Voltage	6 VDC. 15 Vp-p.
4.6	Insulation Resistance R_i , ($M\Omega$) min	100 (100V, 1min)
4.7	Operating Temperature (°C)	-40~+85
4.8	Storage Temperature (°C)	-55~+85
4.9	Aging Rate (%) max	± 0.3 (For 10 years)

5. MEASUREMENT:

Measurement Conditions: Parts shall be measured under a condition (Temp. : 20 ± 15 °C, Humidity : $65\pm 20\%$ R.H.) unless the standard condition(Temp. : 25 ± 3 °C, Humidity : $65\pm 5\%$ R.H.) is regulated to measure.

Test Circuit:



6.PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test		Performance Requirements
6.1	Humidity	Keep the resonator at $40\pm2^\circ\text{C}$ and 90-95% RH for 96 ± 4 hours. Then Release the resonator into the room Condition for 1 hour prior to the Measurement.		It shall fulfill the specifications in Table 1.
6.2	Vibration	Subject the resonator to vibration for 2 hours each in x, y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.		It shall fulfill the specifications in Table 1.
6.3	Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.		It shall fulfill the specifications in Table 1.
6.4	Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1 hour before measurement.		It shall fulfill the specifications in Table 1.
		Temperature at the surface of the substrate	Time	
		Preheat $150\pm5^\circ\text{C}$	60 ± 10 sec	
		Peak $240\pm5^\circ\text{C}$	10 ± 3 sec	
6.5	Solder Ability	Dipped in $230\pm5^\circ\text{C}$ solder bath for 3 ± 0.5 sec seconds with rosin flux (25wt% ethanol solution.)		The terminals shall be at least 95% covered by solder.
6.6	High Temperature Exposure	Subject the resonator to $80\pm5^\circ\text{C}$ for 96 hours, then release the resonator into the room conditions for 1 hour prior to the measurement.		It shall fulfill the specifications in Table 1.
6.7	Low Temperature Exposure	Subject the resonator to $-20\pm5^\circ\text{C}$ for 96 hours, then release the resonator into the room conditions for 1 hour prior to the measurement.		It shall fulfill the specifications in Table 1.

6. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

(Continued from the preceding page)

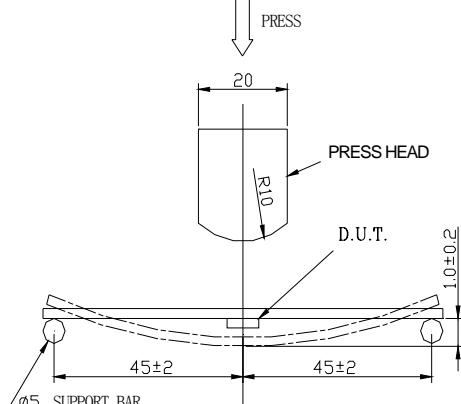
No	Item	Condition of Test	Performance Requirements
6.8	Temperature Cycling	<p>Subject the resonator to -40 °C for 30 min. followed by a high temperature of 85°C for 30 min.</p> <p>Cycling shall be repeated 5 times with a transfer time of 15 sec. At the room temperature for 1 hour prior to the measurement.</p>	It shall fulfill the specifications in Table 1.
6.9	Board Bending	<p>Mount a glass-epoxy board (Width=40mm, thickness=1.6mm), then bend it to 1mm displacement and keep it for 5 seconds. (See the following figure)</p> 	Mechanical damage such as breaks shall not occur.

TABLE 1

Item	Specification
Oscillation Frequency Change △Fosc/Fosc (%) max	±0.3
Resonant Impedance Change △Ro(Ω)max	±10

Note: The limits in the above table are referenced to the initial measurements.

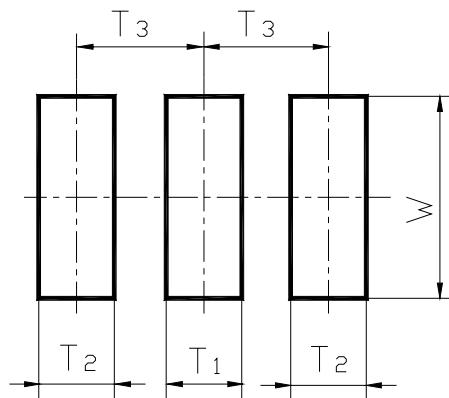
7. REVIEW OF SPECIFICATIONS

When something gets doubtful with this specifications, we shall jointly work to get an agreement.

8. RECOMMENDED LAND PATTERN AND REFLOW SOLDERING

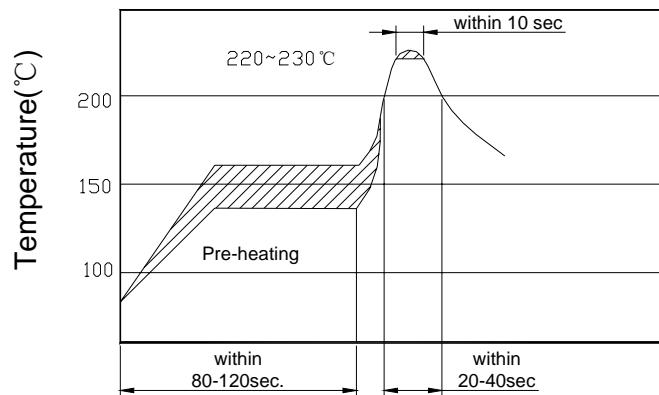
STANDARD CONDITIONS

8.1 Recommended land pattern



DIMENSIONS (mm)			
T ₁	T ₂	T ₃	W ₁
1.0±0.2	0.7±0.2	1.5±0.2	4.1±0.2

8.2 Recommended reflow soldering standard conditions



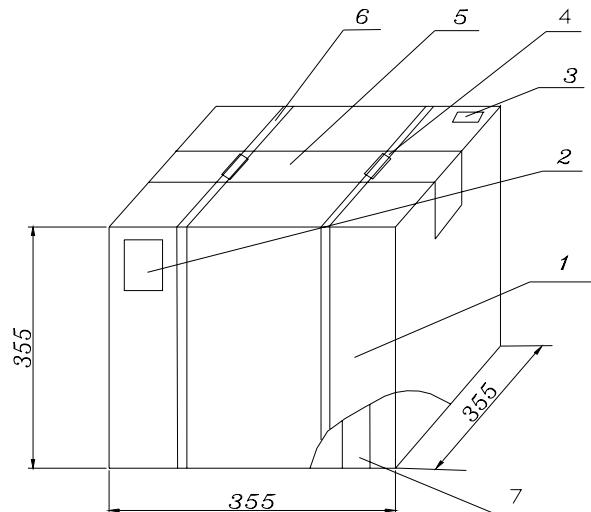
9. PACKAGE

To protect the products in storage and transportation, it is necessary to pack them (outer and inner package). On paper pack, the following requirements are requested.

a) Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



NO.	Name	Quantity	Notes
1	Package	1	
2	Certificate of approval	1	
3	Label	1	
4	Tying	2	
5	Adhesive tape	1.2m	
6	Belt	2.9m	
7	Inner Box	10	

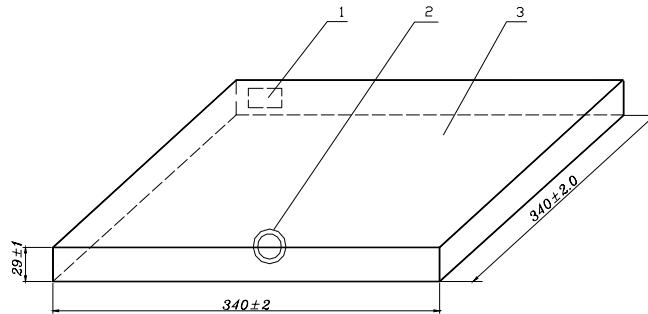
b) Section of package

Package is made of corrugated paper with thickness of 0.8cm. Package has 10 inner boxes, each box has 1 reel(each reel for plastic bag)

c) Quantity of package

Per plastic reel	4000 pieces of piezoelectric ceramic part
Per inner box	1 reel
Per package	10 inner boxes (40000 pieces of piezoelectric ceramic part)

d) Inner Packing Dimensions

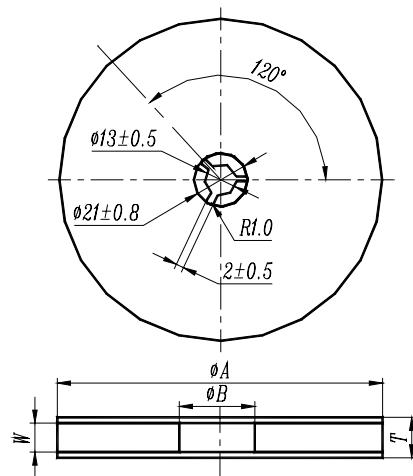


1	Label
2	QC Label
3	Inner Box

1.UNIT: mm

Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.

8.5Reel

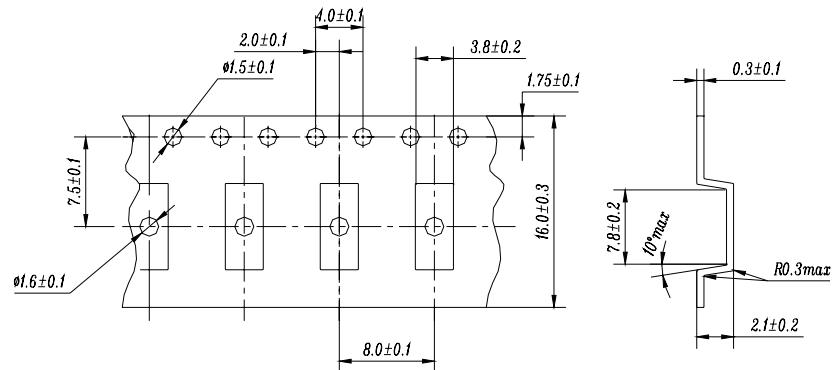


Dimensions

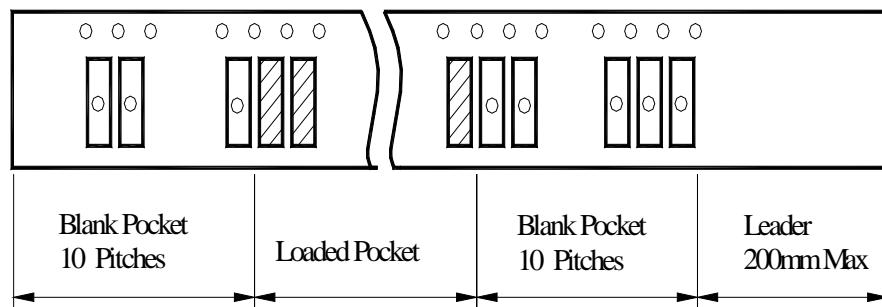
Unit: mm

ØA	ØB	W	T	Pieces per reel	Carrier tape size
330±3	80min	16.4min	22.4max	4000typ.	16

8.6 Taping Dimensions



8.7 Packing Method Sketch Map



8.8 Test Condition Of Peeling Strength

